

X02xxxN

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth(j-a)	Junction to ambient *	60	°C/W
Rth(j-t)	Junction to tab for DC	25	°C/W

* : With 5cm² copper (e=35μm) surface under tab.

GATE CHARACTERISTICS (maximum values)

P_{G(AV)} = 0.2 W P_{GM} = 3 W (tp = 20 μs) I_{GM} = 1.2 A (tp = 20 μs)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Sensitivity			Unit
				02	03	05	
I _{GT}	V _D =12V (DC) R _L =140Ω	T _j = 25°C	MIN		20	20	μA
			MAX	200	200	50	
V _{GT}	V _D =12V (DC) R _L =140Ω	T _j = 25°C	MAX	0.8			V
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ R _{GK} = 1 KΩ	T _j = 125°C	MIN	0.1			V
V _{RGM}	I _{RG} =10μA	T _j = 25°C	MIN	8			V
tgd	V _D =V _{DRM} I _{TM} = 3 x I _{T(AV)} dI _G /dt = 0.1A/μs I _G = 10mA	T _j = 25°C	TYP	0.5			μs
I _H	I _T = 50mA R _{GK} = 1 KΩ	T _j = 25°C	MAX	5			mA
I _L	I _G =1mA R _{GK} = 1 KΩ	T _j = 25°C	MAX	6			mA
V _{TM}	I _{TM} = 2.8A tp= 380μs	T _j = 25°C	MAX	1.5			V
I _{DRM} I _{RRM}	V _D = V _{DRM} R _{GK} = 1 KΩ V _R = V _{RRM}	T _j = 25°C	MAX	5			μA
		T _j = 110°C	MAX	200			μA
dV/dt	V _D =67%V _{DRM} R _{GK} = 1 KΩ	T _j = 110°C	TYP	15	20	15	V/μs
tq	I _{TM} = 3 x I _{T(AV)} V _R =35V dI/dt=10A/μs tp=100μs dV/dt=2V/μs V _D = 67%V _{DRM} R _{GK} = 1 KΩ	T _j = 110°C	MAX	100			μs

ORDERING INFORMATION

X	02	03	M	N
SCR TOP GLASS	CURRENT	SENSITIVITY	VOLTAGE	PACKAGE : N = SOT223

Fig.1 : Maximum average power dissipation versus average on-state current.

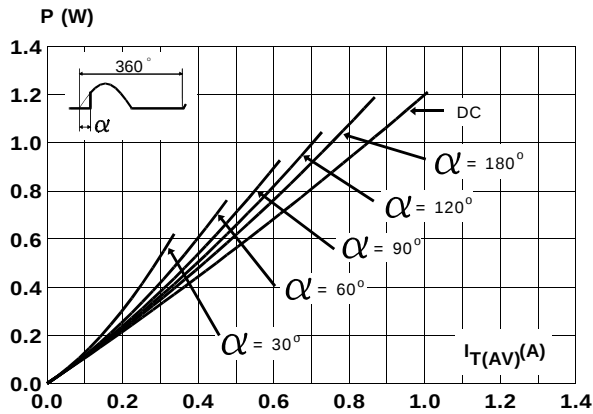


Fig.2 : Correlation between maximum average power dissipation and maximum allowable temperature (T_{amb} and T_{tab}).

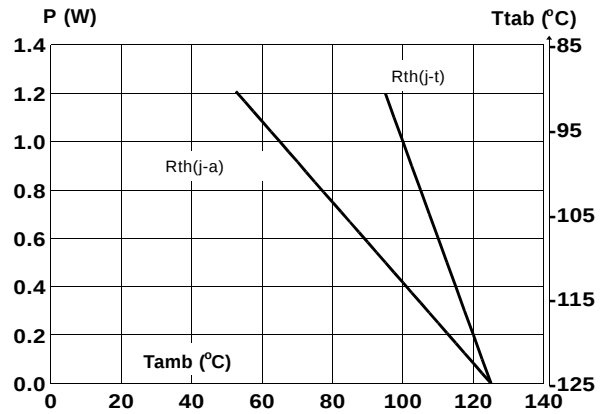


Fig.3 : Average on-state current versus tab temperature.

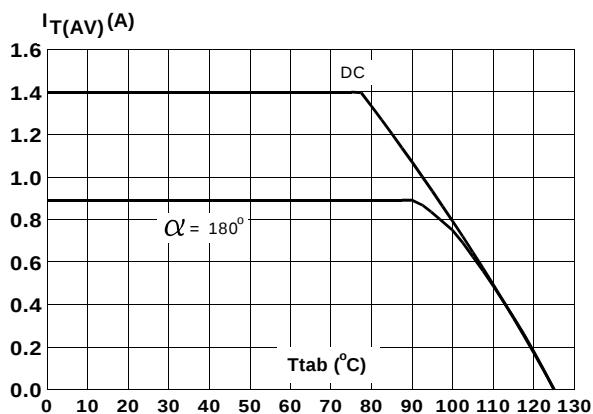


Fig.4 : Relative variation of thermal impedance junction to ambient versus pulse duration.

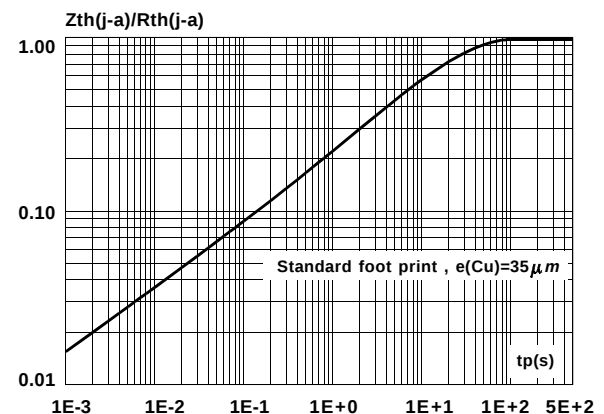


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

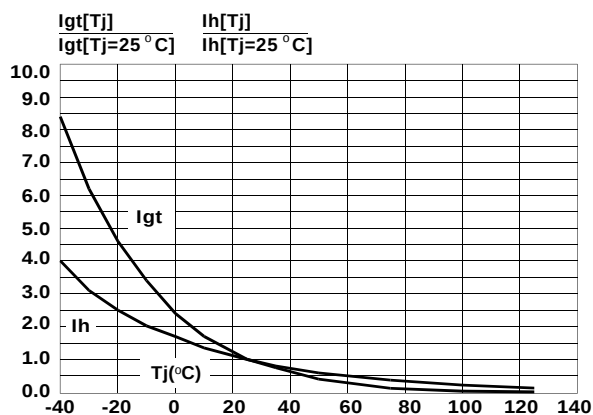


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.

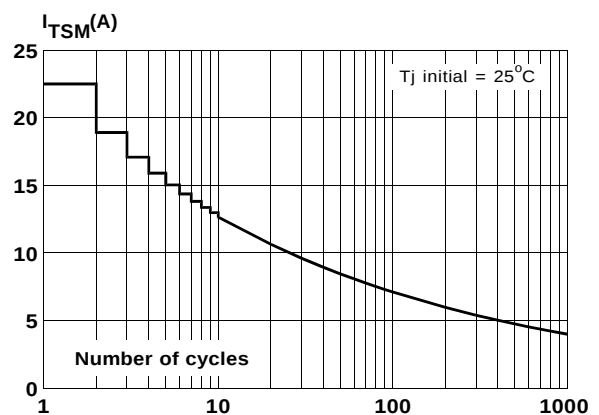


Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t_p \leq 10\text{ms}$, and corresponding value of I^2t .

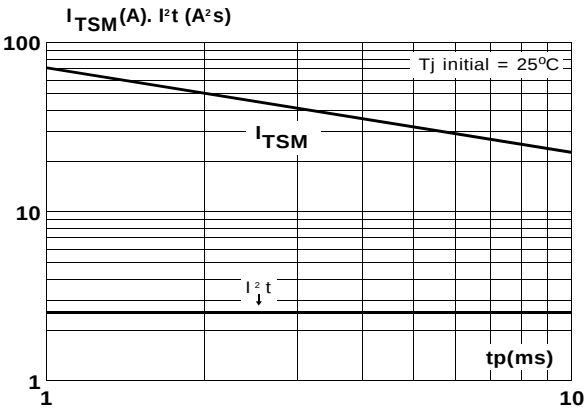
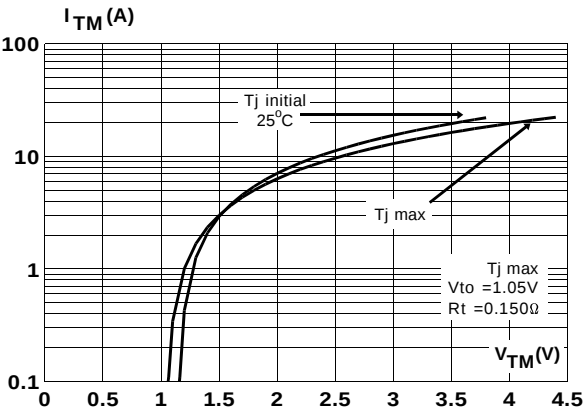
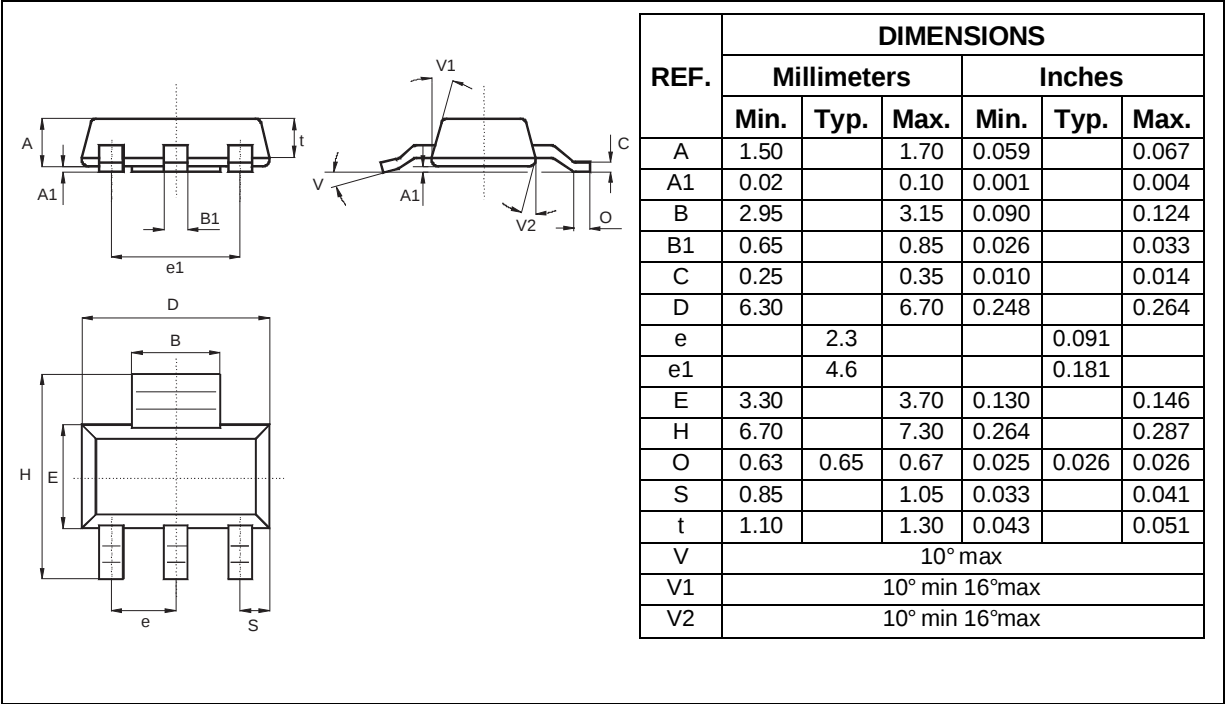


Fig.8 : On-state characteristics (maximum values).



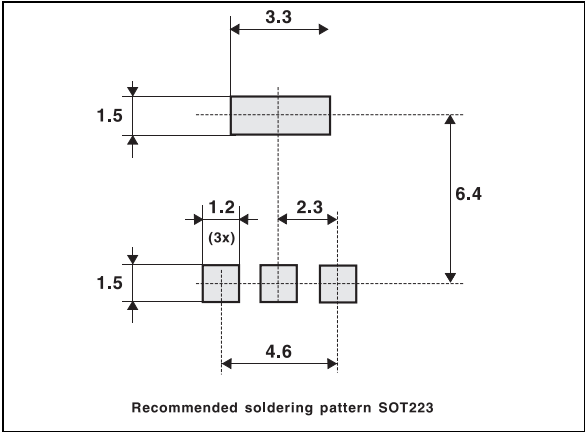
PACKAGE MECHANICAL DATA
SOT223 (Plastic)



Weight : 0.11 g

MARKING

FOOT PRINT



Type	Marking
X0202BN	X2B
X0202DN	X2D
X0202MN	X2M
X0202NN	X2N
X0203BN	X3B
X0203DN	X3D
X0203MN	X3M
X0203NN	X3N
X0205BN	X5B
X0205DN	X5D
X0205MN	X5M
X0205NN	X5N

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